

2822

TRANSMITTAL OF INFORMATION DISCLOSURE STATEMENT
(Under 37 CFR 1.97(b), 1.97(c), or 1.97(d))

Docket No.

MICR135.02

In Re Application of: Jerrold L. King, et al.

Serial No.

Filing Date

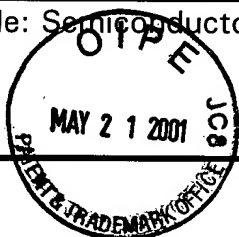
Examiner

Group Art Unit

09/834,696

April 12, 2001

Title: Semiconductor Chip Process



Address to:
Assistant Commissioner for Patents
Washington, D.C. 20231

37 CFR 1.97(b)

- ☒ The Information Disclosure Statement submitted herewith is being filed within three months of the filing of a national application; within three months of the date of entry national stage as set forth in 37 CFR 1.491 in an international application; or before the mailing date of a first office action on the merits, whichever event occurs last.

37 CFR 1.97(c)

- ☐ The Information Disclosure Statement submitted herewith is being filed after three months of a national application, or the date of entry of the national stage as set forth in 37 CFR 1.491 in an international application; or after the mailing date of a first Office Action on the merits, whichever occurred last but before the mailing date of either:

1. a Final Action under 37 CFR 1.113, or
2. a Notice of Allowance under 37 CFR 1.311,

whichever occurs first.

Also submitted herewith is:

- ☐ a certification as specified in 37 CFR 1.97 (e)

OR

- ☐ the fee set forth in 37 CFR 1.117(p) for submission of an Information Disclosure Statement under 37 CFR 1.97(c).

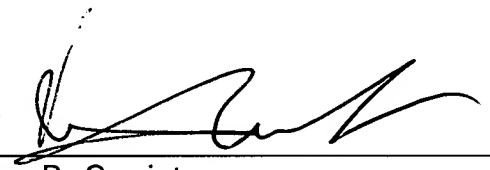
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37 CFR 1.97(d)

- ☐ The Information Disclosure Statement submitted herewith is being filed after a Final Action under Section 1.113, or a Notice of Allowance under Section 1.311, whichever occurs first, but before, or simultaneously with, the payment of the issue fee. Submitted herewith is a certification as specified in 37 CFR 1.97(e).

Applicant hereby petitions for consideration of the Information Disclosure Statement submitted herewith. The Petition Fee specified in 37 CFR 1.17(i) is enclosed.

- ☒ No additional fee is required.
☐ A check in the amount of \$ _____ is attached.



Steven R. Ormiston
Attorney for the Applicant
Reg. No. 35,974

Dated: 5/16/01



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CERTIFICATE OF MAILING

I HEREBY CERTIFY that this correspondence is being deposited with the United States Postal Service as first class mail in an envelope addressed to the Assistant Commissioner for Patents, Washington, DC 20231 on: May 16, 2001



Signature

Tanya F. Pauls

Printed Name